

N and P-Channel Enhancement Mode Power MOSFET

Description

The NCE4606 uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

General Features

N-Channel

 $V_{DS} = 30V, I_{D} = 6.5A$

 $R_{DS(ON)}$ < 24m Ω @ V_{GS} =10V

 $R_{DS(ON)}$ < 37m Ω @ V_{GS} =4.5V

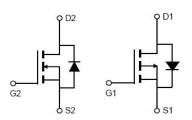
P-Channel

 $V_{DS} = -30V, I_{D} = -7A$

 $R_{DS(ON)}$ < 32m Ω @ V_{GS} =-10V

 $R_{DS(ON)}$ < 70m Ω @ V_{GS} =-4.5V

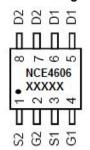
- High power and current handing capability
- Lead free product is acquired
- Surface mount package
- MSL3 up to 260°C peak reflow



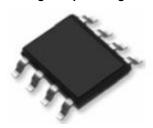
N-channel

P-channel

Schematic diagram



Marking and pin assignment



SOP-8 top view

Package Marking and Ordering Information

	J	<u> </u>			
Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE4606	NCE4606	SOP-8	Ø330mm	12mm	4000 units

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter		Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage		V _{DS}	30	-30	V	
Gate-Source Voltage		V _{GS}	±20	±20	V	
Continuous Dusin Comment	T _A =25℃		6.5	-7	•	
Continuous Drain Current	T _A =70℃	lD	5.4	-5.8	Α	
Pulsed Drain Current (Note 1)		Ідм	30	-30	Α	
Maximum Power Dissipation T _A =25℃		P _D	2.0	2.0	W	
Single pulse avalanche energy (Note 6)		E _{AS}	39	72	mJ	
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55 To 150	-55 To 150	$^{\circ}$ C	

Thermal Characteristic

Thermal Resistance,Junction-to-Ambient (Note2)	R _{0JA}	N-Ch	62.5	°C/W
Thermal Resistance,Junction-to-Ambient (Note2)	R _{0JA}	P-Ch	62.5	°C/W



N-CH Electrical Characteristics (T_A=25 °C unless otherwise noted)

Parameter	Symbol	Condition		Min	Тур	Max	Unit
Off Characteristics	•				•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =2	50µA	30	33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS}	s=0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _D	vs=0V	-	-	±100	nA
On Characteristics (Note 3)	'						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA		1	1.6	2.5	V
			T _J =25°C	-	19	24	
		V _{GS} =10V, I _D =6A	T _J =125℃	-	30	39	mΩ
D : 0 0 0 1 D : 1			T _J =150°C	-	34	44	
Drain-Source On-State Resistance	R _{DS(ON)}		T _J =25°C	-	26	37	mΩ
		V _{GS} =4.5V, I _D =6A	T _J =125℃	-	41	58	
			T _J =150°C	-	45.5	64	
Gate resistance	R _G	V _{DS} =0V,V _{GS} =0V,F=1.0MHz		-	1.1	-	Ω
Forward Transconductance	g FS	V _{DS} =5V,I _D =6A		15	-	-	S
Dynamic Characteristics (Note4)	1			'	l		
Input Capacitance	C _{iss}	V _{DS} =15V,V _{GS} =0V, F=1.0MHz		-	530.3	-	PF
Output Capacitance	Coss			-	67.1	-	PF
Reverse Transfer Capacitance	C _{rss}			-	61.2	-	PF
Switching Characteristics (Note 4)		1		'	1		
Turn-on Delay Time	t _{d(on)}			-	4.5	-	nS
Turn-on Rise Time	t _r	V _{DD} =15V, I _D =6A		-	2.5	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _{GE}	_N =3Ω	-	14.5	-	nS
Turn-Off Fall Time	t _f			-	3.5	-	nS
Total Gate Charge	Qg	\/ 45\/ L	0.4	-	14.2	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =15V,I _D =6A,		-	1.8	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V		-	3.3	-	nC
Drain-Source Diode Characteristics	•					· · · · · ·	
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =6A		-	0.8	1.2	V
Diode Forward Current (Note 2)	Is			-	-	6.5	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = I _S		_	10	-	nS
Reverse Recovery Time	1 ""	10 == =,	.0				



P-CH Electrical Characteristics (T_A=25 °C unless otherwise noted)

Parameter	Symbol	ol Condition		Min	Тур	Max	Unit
Off Characteristics				1	. .		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA		-30	-33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V,V _{GS}	=0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS}	=0V	-	-	±100	nA
On Characteristics (Note 3)							
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-25	50μA	-1.3	-1.65	-2.5	V
			TJ=25°C	-	28	32	
		V _{GS} =-10V, I _D =-6.5A	TJ=125℃	-	41	48	mΩ
			T _J =150°C	-	45	52	
Drain-Source On-State Resistance	R _{DS(ON)}		TJ=25℃	-	49	70	mΩ
		V _{GS} =-4.5V, I _D =-6.5A	T _J =125℃		63	89	
		, _ ,	T _J =150℃		67.5	96	
Gate resistance	R _G	V _{DS} =0V,V _{GS} =0V,F=1.0MHz		-	4.2	-	Ω
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-6.5A		10	-	-	S
Dynamic Characteristics (Note4)							
Input Capacitance	C _{lss}	- V _{DS} =-15V,V _{GS} =0V,		-	729.4	-	PF
Output Capacitance	Coss			-	112.6	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz		-	107.5	-	PF
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}			-	7.5	-	nS
Turn-on Rise Time	t _r	V _{DD} =-15V, I _D =-6.5A		-	5.5	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{GEN} =6 Ω		-	19	-	nS
Turn-Off Fall Time	t _f			-	7	-	nS
Total Gate Charge	Qg			-	16.6	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-15V,I _D =-6.5A		-	1.8	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =-10V		-	4.2	-	nC
Drain-Source Diode Characteristics				1		1	
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-6.5A		-	-	-1.2	V
Diode Forward Current (Note 2)	Is			-	-	-7	Α
Reverse Recovery Time	t _{rr}	$T_J = 25$ °C, $I_F = I_S$ di/dt = 100A/ μ s ^(Note3)		-	15	-	nS
Reverse Recovery Charge	Qrr			-	10	-	nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤ 300μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production



N- Channel Typical Electrical and Thermal Characteristics (Curves)

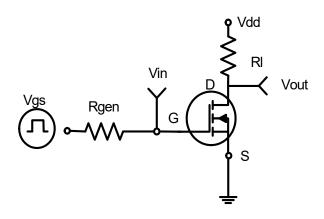


Figure 1:Switching Test Circuit

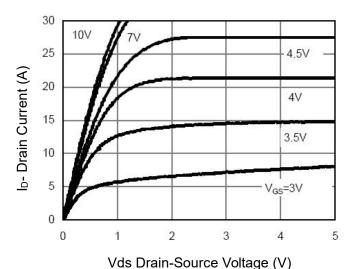


Figure 3 Output Characteristics

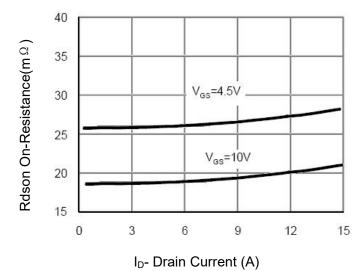


Figure 5 Drain-Source On-Resistance

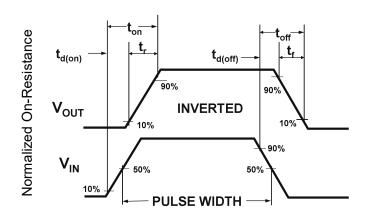


Figure 2:Switching Waveforms

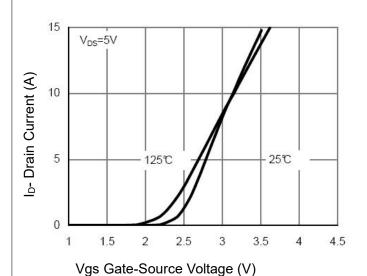


Figure 4 Transfer Characteristics

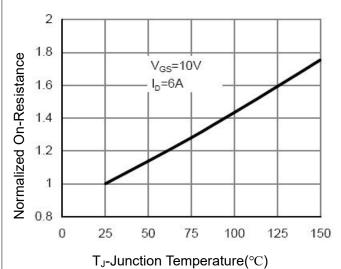


Figure 6 Drain-Source On-Resistance



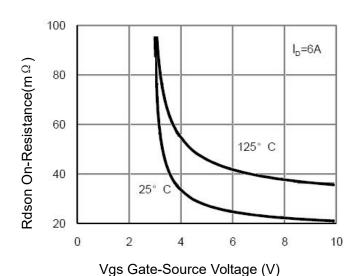
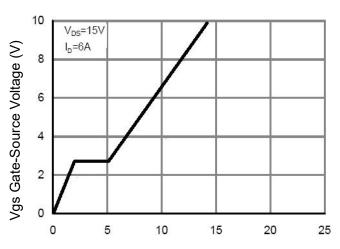
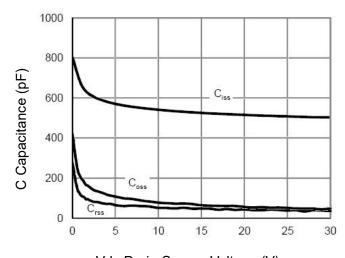


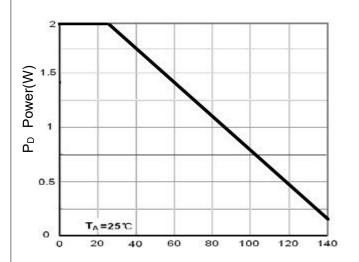
Figure 7 Rdson vs Vgs



Qg Gate Charge (nC) Figure 9 Gate Charge



Vds Drain-Source Voltage (V)
Figure 11 Capacitance vs Vds



T_J-Junction Temperature(°C) Figure 8 Power Dissipation

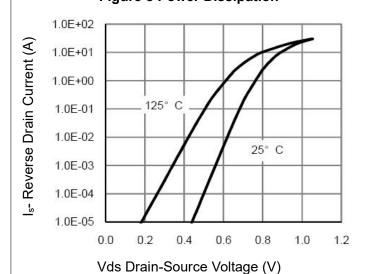


Figure 10 Source- Drain Diode Forward

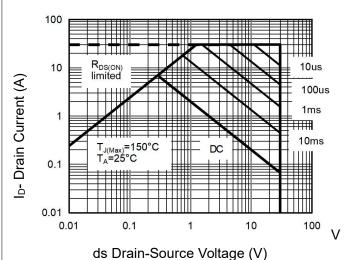


Figure 12 Safe Operation Area



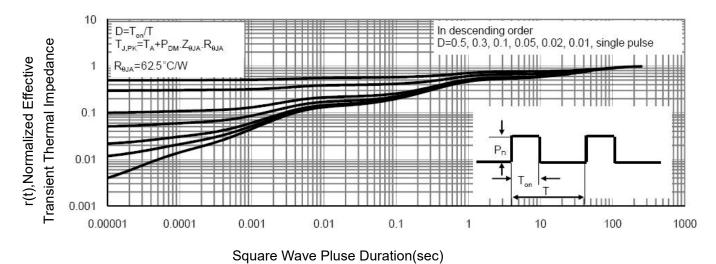


Figure 13 Normalized Maximum Transient Thermal Impedance



P- Channel Typical Electrical and Thermal Characteristics (Curves)

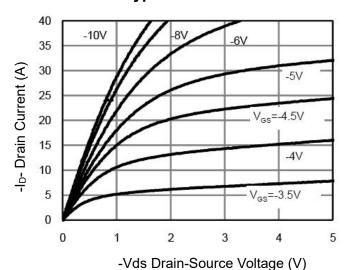
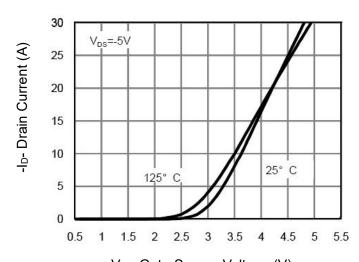


Figure 1 Output Characteristics



-Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

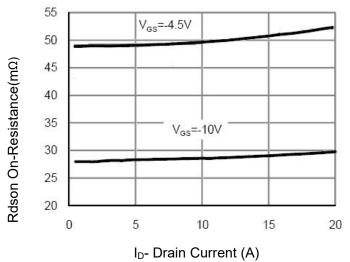


Figure 3 Rdson- Drain Current

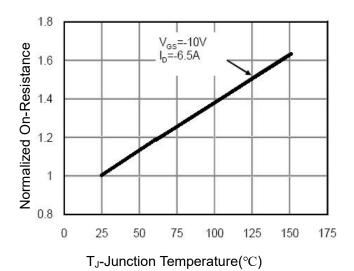


Figure 4 Rdson-Junction Temperature

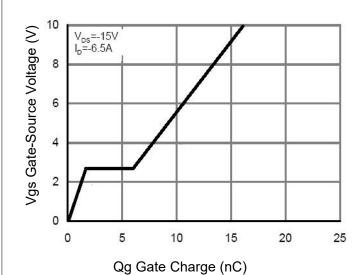


Figure 5 Gate Charge

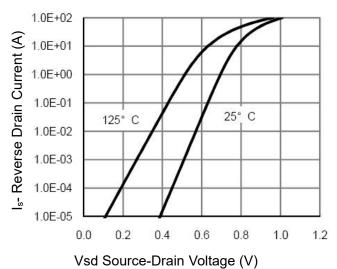


Figure 6 Source- Drain Diode Forward



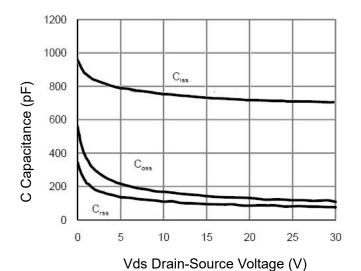


Figure 7 Capacitance vs Vds

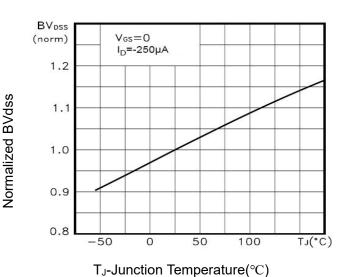


Figure 9 BV_{DSS} vs Junction Temperature

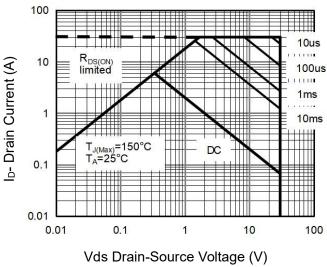


Figure 8 Safe Operation Area

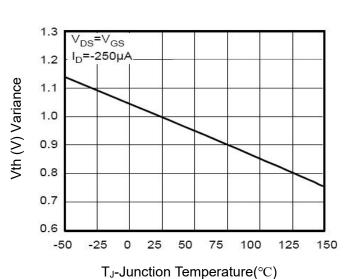


Figure 10 V_{GS(th)} vs Junction Temperature

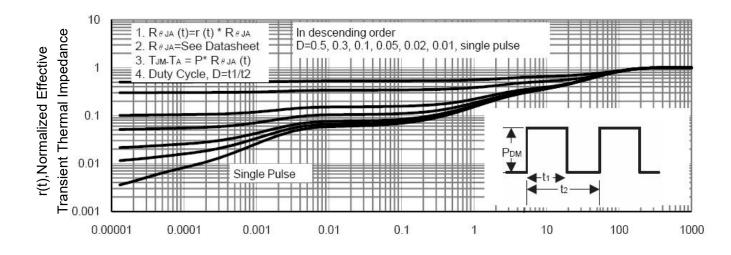
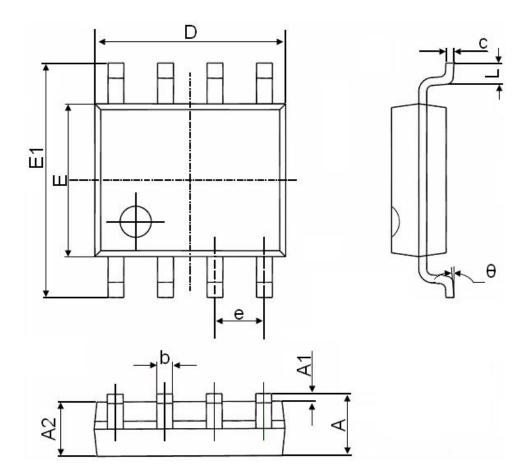


Figure 11 Normalized Maximum Transient Thermal Impedance

Square Wave Pluse Duration(sec)



SOP-8 Package Information



Comple ed	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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